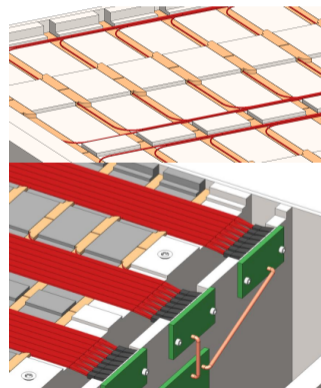
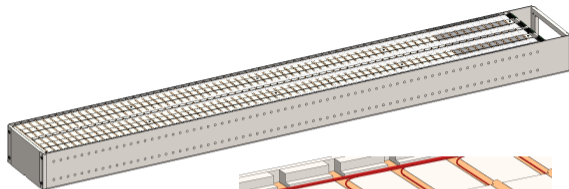
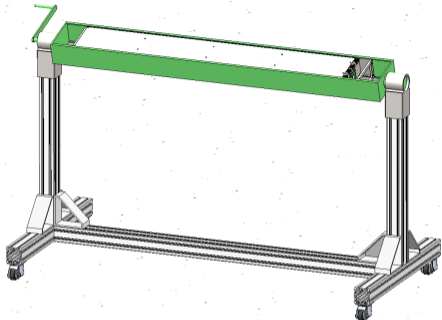


# **Longitudinally separated Forward HCal (LFHCal) Module Assembly**

**November 1, 2022**

**Friederike Bock (ORNL)  
for the LFHCal crew**

# 8M assembly overview

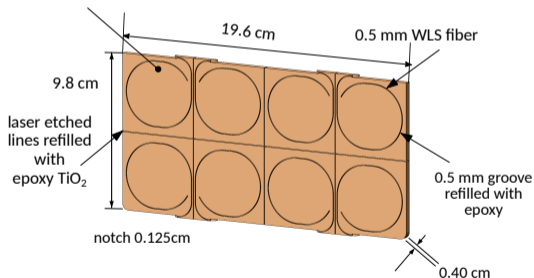


- a) single tile assembly (fiber embedding, glueing, wrapping)
- b) tile testing
- c) assembly of module, alternating steel plate first kept in place by e-beam point welding then Scint-tile
- d) fiber channels layed out on front on back
- e) SiPM & read-out card installation
- f) tower testing
- g) close up module with cover plates

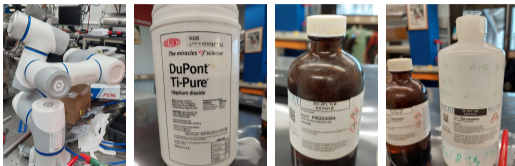
- Most scintillator plates produced as 1 unit of 100x200mm plates (8 single tower tiles)
- Separation of tiles edged into the plate (95%) through, refilled with Epoxy-TiO<sub>2</sub> mix

## 8M LFHCal Scintillator Tile

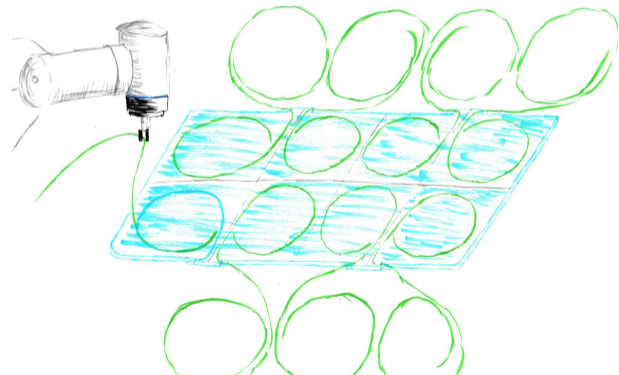
Plastic (Polystyrene)



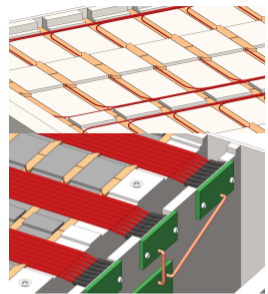
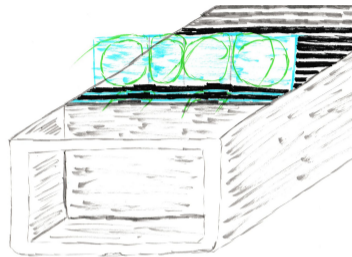
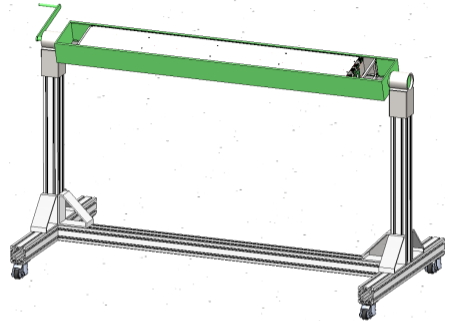
- Fiber thickness chosen for minimal light loss while bending (0.5mm)  
→ other geometries for embedding under consideration (i.e. 1/4 circle)
- Exploring possible robot supported options for tile assembly



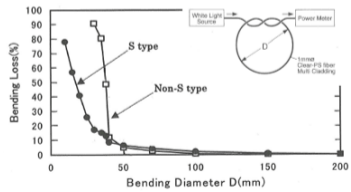
- ① Refilling of gaps with  $\text{TiO}_2$ -Epoxy mix using collaborative robot
- ② Measuring fiber quality & cutting to desired length
- ③ Laying WLS-fibers in groove, fixating them using a few glue dots
- ④ Roll WLS-fibers up on try with tile
- ⑤ Might need additional coating with white paint
- ⑥ Stack trays & transport to 8M assembly site



# 8M assembly detail



- a) Mount assembled steel/tungsten frame in pivot
- b) Slot scintillator tiles in frame from back to front  
Fibers for bottom side slotted through, caught by tray on bottom
- c) After 10 tiles sort fibers 5/5 & place plastic strip as separator, tape on top
- d) Continue till top side finished & cut length of fibers to fit readout
- e) install cover plate
- f) Flip module in pivot, remove tray
- g) Sort fibers & assemble as on top

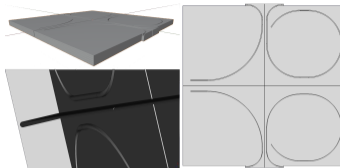


# Back-up



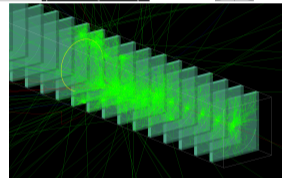
① **Prototype tile production using machining & injection molding (04/23)**

- ▶ Assembled prototype tiles using machined scintillator plates
- ▶ Assembled prototype tiles using injection molded scintillator tiles
- ▶ Documentation of procedures for manual assembly of tiles & WLS fibers



② **Reconstruction optimization (09/23)**

- ▶ Write-up of optimization results from simulations



③ **Sensor board development (07/23)**

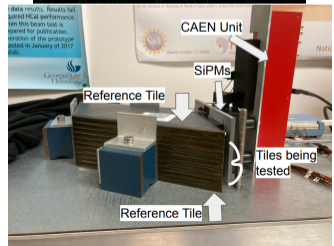
- ▶ First prototype of sensor board for Si-PM readout (together with eRD109)

④ **Small test module assembly (07/23)**

- ▶ First prototype of single segment of 8M module

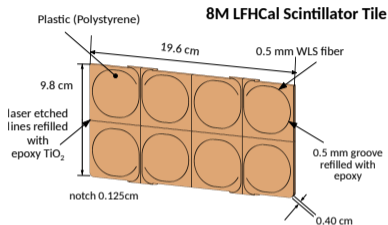
⑤ **First automated scintillator tile assembly (08/23)**

- ▶ Assembled prototype tiles
- ▶ Documentation and Evaluation of procedures for automated assembly of tiles & WLS fibers

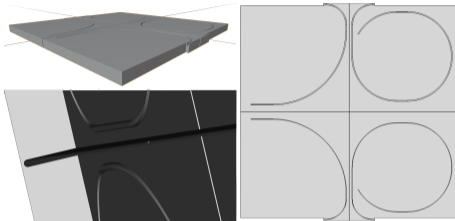


⑥ **Tile Characterization (08/23)**

- ▶ Write-up of test bench & test beam measurement for all assembled tile-prototypes



8M LFHCal Scintillator Tile



## Prototype tile production using machining & injection molding

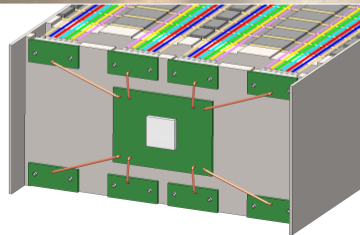
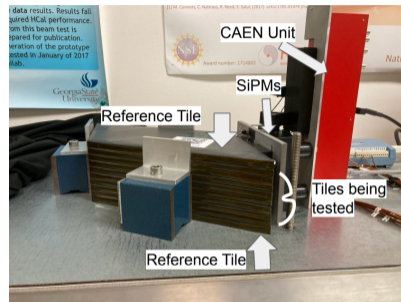
- Vendor replacement needed for Uniplast
  - a) Machining plastic scintillator plates (~ \$80/tile)
  - b) Injection molding tile (~ \$4 – 6/tile)
- Opportunity for significant cost reduction w/ injection molding
- Performance and mechanical stability tests needed in both cases

## First automated scintillator tile assembly

- Tile assembly time & labor extensive w/ classical methods
- Exploring automated assembly using collaborative robots for:
  - ▶ Refilling sub-segmentation with TiO<sub>2</sub>
  - ▶ Fiber laying and fixating in groves
  - ▶ Automatic measurements of WLS-fiber quality



- Characterization of assembled tiles according to:
  - ▶ Light yield
  - ▶ Cross-talk among different tiles
  - ▶ Response uniformity
  - ▶ Durability and mechanical stability
- Initial geometry optimization using TracePro simulations
- Usage of available test-stands at universities for tile characterization
- Possibility to test multiple scintillator materials/dopant concentration in particular for injection molding
- Development of a SiPM board and WLS fiber connector suitable for production module



- Successively-larger R&D prototype assembly
  - ① Scintillator tiles
  - ② Single segment of 8M module (20cm) including initial read-out design
  - ③ Full mechanical mock-up of 8M module
  - ④ Full 8M modules including initial read-out design
- Main measurements
  - ▶ Characterization of spatial distribution and uniformity of MIP response for different tile types
  - ▶ Saturation behavior of combined tile and SiPM readout system for single segment
  - ▶ Measuring the individual and combined response of tiles to EM-showers
  - ▶ Spatial and energy resolution of partial and full module LFHCAL module
  - ▶ Combined test-beam w/ pECal to characterize LFHCAL partial and full module response behind ECal
- Current Read-out electronics design based on CMS-SiPM-HGCROC (ASIC)  
Final electronics R&D for EIC specific readout board within eRD109 based on same ASIC with possible small modifications

# eRD107 Funding request

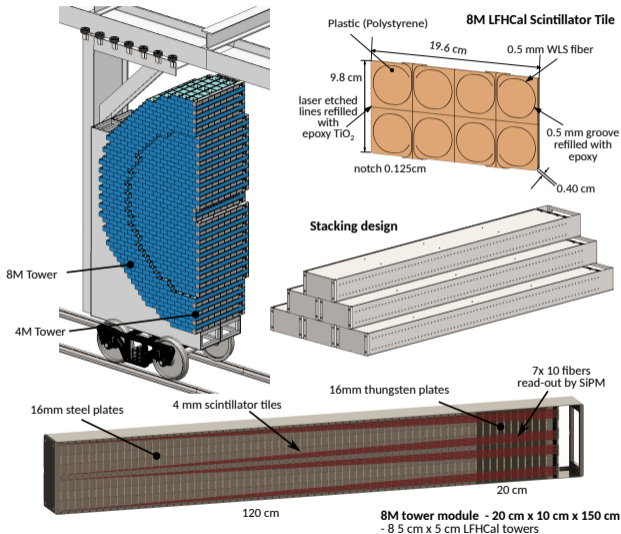
activity	cost in FY23 k\$									total cost in FY23 k\$
	ORNL	FNAL	BNL	UTK	GSU	Yale	ISU	Valpo	UCR	
Machined Tiles	11.7	0	0	0	0	0	0	0	0	11.7
Injection Molded Tiles	2.0	52.9	0	0	0	0	0	0	0	54.9
Auto Tile Assembly	20.0	0	0	0	0	0	0	0	0	20.0
Tile Char. (Lab)	16.0	0	0	0	0	0	0	0	0	16.0
Sensor Board	12.2	0	0	0	0	0	0	0	0	12.2
LFHCAL Mechanics	21.7	0	0	0	0	0	0	0	0	21.7
Tile Char. (Beam)	1.0	0	2.0	2.0	2.0	2.0	2.0	1.0	2.0	14.0
<b>Total</b>	<b>84.6</b>	<b>52.9</b>	<b>2.0</b>	<b>2.0</b>	<b>2.0</b>	<b>2.0</b>	<b>2.0</b>	<b>1.0</b>	<b>2.0</b>	<b>150.5</b>

institute	cost in FY23 k\$				total cost in FY23 k\$
	eng. and tech.	material	equipment	travel	
ORNL	29.8	16.8	36.0	2.0	84.6
FNAL	52.9	0	0	0.0	52.9
BNL	0	0	0	2.0	2.0
UTK	0	0	0	2.0	2.0
GSU	0	0	0	2.0	2.0
Yale	0	0	0	2.0	2.0
ISU	0	0	0	2.0	2.0
Valpo	0	0	0	1.0	1.0
UCR	0	0	0	2.0	2.0
<b>Total</b>	<b>82.7</b>	<b>16.8</b>	<b>36.0</b>	<b>15.0</b>	<b>150.5</b>

- Largest fraction of funding for engineers and technicians
- Additional funds used for material, test equipment & travel for test beam campaigns
- Significant in-kind contribution from universities and laboratories for assembly, simulation and data analysis (~ 2140h)
- Parallel PED request for mechanical & electrical engineering support will be submitted to further final design of LFHCAL

Task	Estimated cost in \$ per year		
	FY24	FY25	FY26
mechanical engineering	40K	40K	20K
electrical engineering	30K	30K	20K
materials	30K	30K	40K
test beam support	10K	10K	10K
<b>total</b>	<b>110K</b>	<b>110K</b>	<b>90K</b>

# Calorimeter Details & PED request



parameter	LFHCal
inner radius (envelope)	17 cm
outer radius (envelope)	270 cm
$\eta$ acceptance	$1.2 < \eta < 3.5$
tower information	
x, y ( $R < / > 0.8$ m)	5 cm
z (active depth)	140 cm
z read-out	10 cm
# scintillator plates	70 (0.4 cm each)
# absorber sheets	60 (1.6 cm steel)
	10 (1.6 cm tungsten)
weight	$\sim 30.6$ kg
interaction lengths	$6.9 \lambda / \lambda_0$
Molière radius $R_M$	21.1 cm ( $\pi^\pm$ shower)
Sampling fraction $f$	0.040
# towers (inner/outer)	9040
# modules	
8M	1091
4M	76
2M	2
1M	4
# read-out channels	$7 \times 9,040 = 63,280$

activity	cost in FY23 k\$		total cost in FY23 k\$
	ORNL	BNL	
Support structure design & integration with pEcal	75	0	75
Rail/slide design	0	50	50
test production of module	20	0	20
tooling design + function test	50	0	50
<b>Total</b>	<b>145</b>	<b>50</b>	<b>195</b>

# eRD107: Detailed cost table

Institute	Item	Cost per item in \$	Number of items	Total cost in \$	To be compl. by
<b>Machined Scintillator Tiles:</b>					
ORNL	BC-408 plastic scintillator sheet	~ 150	20	3K	Q1/2023
ORNL	BCF-91A WLS fiber	1500	1	1.5K	
ORNL	tile machining	180/h	40h	7.2K	Q4/2022
ORNL/UTK	tile assembly		40h	(in kind) 0K	Q4/2022
<b>Injection Molded Scintillator Tiles:</b>					
FNAL	mold design + production	50 000	1	50K	Q2/2023
ORNL	travel			2K	Q4/2022
FNAL	raw material + dopant			(in kind) 0K	
FNAL	injection molder setup + operation	180/h	16h	2.9K	Q1/2023
ORNL/UTK	tile assembly		40h	(in kind) 0K	Q1/2023
<b>Automated Tile Assembly:</b>					
ORNL	robotic arm	20 000	1	20K	2024
ORNL	robot programming and evaluation		40h	(in kind) 0K	Q3/2023
<b>Tile Characterization (Lab Bench):</b>					
ORNL/UTK	scintillator material characterization		20h	(in kind) 0K	Q3/2023
ORNL	waveform sampling readout (8ch)	16000	1	16K	Q2/2023
GSU/Yale/UCR	tile lightyield testing		160h	(in kind) 0K	Q3/2023
ISU/BNL	tile simulation		160h	(in kind) 0K	Q3/2023
<b>Sensor Board:</b>					
ORNL	mechanical engineer	180/h	15h	2.7K	Q1/2023
ORNL	sensors: silicon photomultipliers	30	300	9K	
ORNL	sensor board production, assembly	50	10	0.5K	Q1/2023
<b>Reconstruction Optimization:</b>					
UTK/Yale/BNL	simulations/digitization/reconstruction/analysis		640h	(in kind) 0K	2025
<b>LFHCAL Mechanics:</b>					
ORNL	mechanical engineer	180/h	105h	18.9K	Q3/2023
ORNL	absorber material + fasteners	40	70	2.8K	
UTK/Yale	absorber machining	100/h	20h	(in kind) 0K	Q2/2023
<b>Tile Characterization (Test Beam):</b>					
ORNL	assembly and shipping			1K	
All	test beam travel			13K	
ORNL/UTK	test beam preparation		80h	(in kind) 0K	Q2/2023
ORNL	test beam		120h	(in kind) 0K	Q3/2023
Yale	test beam		120h	(in kind) 0K	Q3/2023
BNL	test beam		120h	(in kind) 0K	Q3/2023
UTK	test beam		120h	(in kind) 0K	Q3/2023
GSU	test beam		120h	(in kind) 0K	Q3/2023
ISU	test beam		120h	(in kind) 0K	Q3/2023
Valpo	test beam		120h	(in kind) 0K	Q3/2023
UCR	test beam		120h	(in kind) 0K	Q3/2023
<b>Total</b>				<b>150.5K</b>	

# Conservative Cost Estimate

## Example 8M module costs:

Material procurement	Units	Unit Pricing
Absorber plates + support	1	\$1750
Scintillator plates	70	\$65
tyvek + capton	4.04	\$0.4
WLS fibers	1360	\$3
<b>8M module cost:</b>	1091	<b>\$9822</b>

Assembly labor	hours	cost
installing fiber mech. engineer	17.5 h	\$2680.5
tile wrapping PhD students	7 h	\$140
tower assembly mech. engineer	0.083 h	\$12.8
tower assembly PhD Student	1.92 h	\$38.4
tower assembly Undergrad	11 h	\$220
tower assembly Postdoc	1 h	\$71
tower assembly PhD Student	4.5	\$90
<b>8M module cost:</b>	1091	<b>\$2252.7</b>

Electronics	Units	Unit Pricing
SiPMs	56	\$10
mounting boards	1	\$10
cable+HV/LV	1	~\$822
<b>8M module cost:</b>	1091	<b>\$1392</b>

## Additional costs:

- R&D cost: 393K
- Tooling: 200K
- Support Structure: 100K
- Installation: 382K

## Total costs:

- estimated for:  
**1091x8M module, 76x4M modules, 2x2M modules, 4x1M modules**
- Module prices don't exactly scale as labor doesn't scale
- Cost adapted to US prices w/o relying on Uniplast
- **total unescalated cost: \$17.7M**  
→ estimates w/ Uniplast quotes \$11.2M